ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	.ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declar the declaratio	ration of n encom	the substance the substance passes all low	s within th er level m	e manufactu aterials for w	rer listed it hich the m	em. Not anufacti	te: if the ite urer has eng	m is an ass gineering r	embly with low esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate 					neous Mater	rials and Mfg Information					
Supplier Information																
Company name* C			Company unique ID			Unique ID Authority					Response Date*					
nsemi												2023-06-08				
Contact Name	Title - Contac	Title - Contact			Phone - Contact*					Email - Contact*						
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com						
authorized Representative*	Title - Representative			Phone - Representative*				Email - Representative*								
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com							
Requester Item Number	Mfr Iter	n Number				Effective Da	ate Ve	Version Manufact		uring Site	V	Veight*	U	ОМ	Unit Type	
	CAS930	C66VP2I-GT3			ОМ	2023-06-08			ТНВ		1	14.87		g	Each	
Aanufacturing Proccess Informa	ation		1			1							L		-	
Terminal Plating / Grid Array M	Iaterial '	Ferminal Base A	Alloy J	J-STD-020 MSL Rating		Peak Process		Body Temperature Max Time at Peak		Temperature Number of Reflo		eflow Cycl	es			
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		l		260		С	30		second	is 3				
omments																
evel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds													
or more information regarding materia	l composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.1	mg	Supplier	Silver (Ag)	7440-22-4		0.075	mg
			Supplier	Epoxy resins	129915-35-1		0.025	mg
Lead Frame	6.18	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0093	mg
			Supplier	Silicon (Si)	7440-21-3		0.0402	mg
			В	Nickel (Ni)	7440-02-0		0.1854	mg
			Supplier	Copper (Cu)	7440-50-8		5.9452	mg
Mold Compound-Black	7.94	mg		Epoxy Phenol Resin	proprietary data		0.8337	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7.1063	mg
Plating	0.12	mg	Supplier	Palladium (Pd)	7440-05-3		0.0075	mg
			В	Nickel (Ni)	7440-02-0		0.1113	mg
			Supplier	Gold (Au)	7440-57-5		0.0013	mg
Wire Bond - Au	0.13	mg	Supplier	Gold (Au)	7440-57-5		0.13	mg